MOSFET – Power, Single, N-Channel, SOT-23, 2.4 x 2.9 x 1.0 mm

20 V, 3.6 A

Features

- Advanced Trench Technology
- Ultra-Low R_{DS(on)} in SOT-23 Package
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Power Load Switch
- Power Management

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parame	Symbol	Value	Unit			
Drain-to-Source Voltage			V _{DSS}	20	V	
Gate-to-Source Voltage			V _{GS}	±8	V	
Continuous Drain Current Steady $T_A = 25^{\circ}C$			۱ _D	3.6	А	
(Note 1)	State	$T_A = 85^{\circ}C$		2.6		
	$t \le 5 \text{ s}$ $T_A = 25^{\circ}C$			6.5		
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	0.47	W	
	t ≤ 5 s			1.56		
Pulsed Drain Current	t _p = 10 μs		I _{DM}	13.2	А	
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C	
Source Current (Body Diode) (Note 2)			۱ _S	2.2	А	
Lead Temperature for Soldering Purposes (1/8 in from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	264	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	80	

1. Surface-mounted on FR4 board using 1 in sq. pad size (Cu area = 1.127 in sq. [1 oz] including traces).

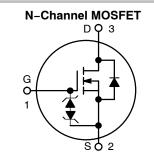
2. Pulse Test: pulse width \leq 300 ms, duty cycle \leq 2%.

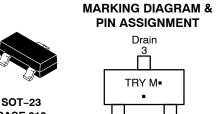


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V _{(BR)DSS}	R _{DS(on)} Max	I _D MAX
	24 mΩ @ 4.5 V	
20 V	26 mΩ @ 3.7 V	
	29 mΩ @ 3.3 V	3.6 A
	33 mΩ @ 2.5 V	
	55 mΩ @ 1.8 V	





2

Source

CASE 318 STYLE 21 1 Gate

.

TRY = Specific Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR3C21NZT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NTR3C21NZT3G	SOT-23 (Pb-Free)	10,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T1 = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 250 \ \mu\text{A}$, ref to 25°C			21.6		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$ \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 20 \ V \end{array} \begin{array}{c} T_{J} = 25^{\circ}C \\ T_{J} = 85^{\circ}C \end{array} $			1.0	μΑ	
			$T_J = 85^{\circ}C$			5.0	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= ±8 V			±10	μΑ
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		0.45		1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	l _D = 5 A		18	24	mΩ
		V _{GS} = 3.7 V	I _D = 4 A		18.5	26	
		V _{GS} = 3.3 V	I _D = 3 A		19	29	
		V _{GS} = 2.5 V	I _D = 2 A		20	33	
		V _{GS} = 1.8 V	l _D = 1 A		25	55	
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 3 A			20		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}				1540		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 16 V			105		
Reverse Transfer Capacitance	C _{rss}				86		
Total Gate Charge	Q _{G(TOT)}				17.8		nC

Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 16 V,
Turn-Off Delay Time	t _{d(off)}	$I_D = 5 \text{ A}, \text{ R}_G = 6.0 \Omega$
Fall Time	t _f	

Q_{G(TH)}

 Q_{GS}

 Q_{GD}

t_{d(on)}

DRAIN-SOURCE DIODE CHARACTERISTICS

SWITCHING CHARACTERISTICS (Note 4)

Threshold Gate Charge

Gate-to-Source Charge

Gate-to-Drain Charge

Turn-On Delay Time

Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$	0.7	1.0	V
		I _S = 2.0 A	T _J = 125°C	0.56		

 V_{GS} = 4.5 V, V_{DS} = 16 V, I_{D} = 5 A

2.1

3.0

0.8

7.0

14

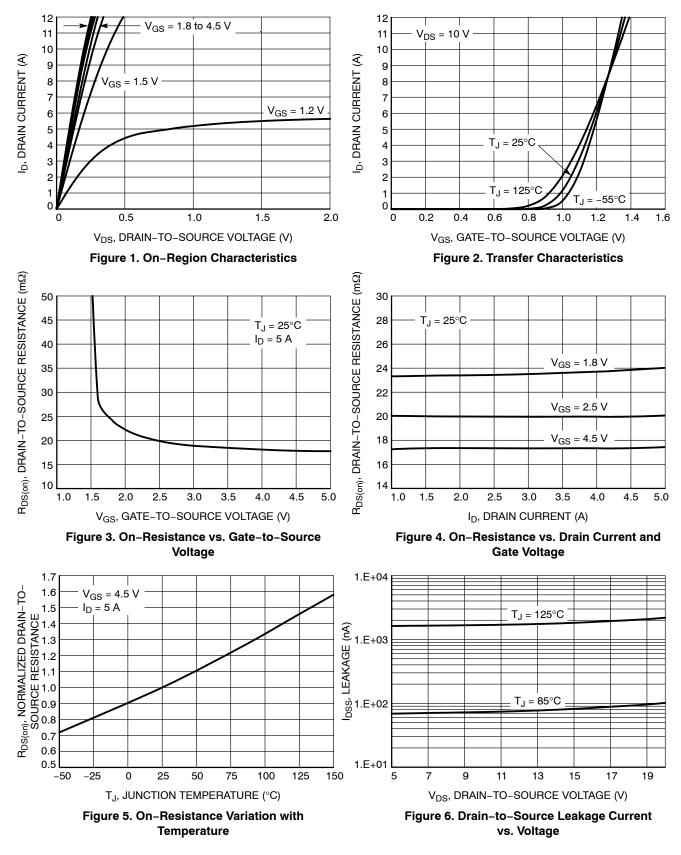
420 4670 ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

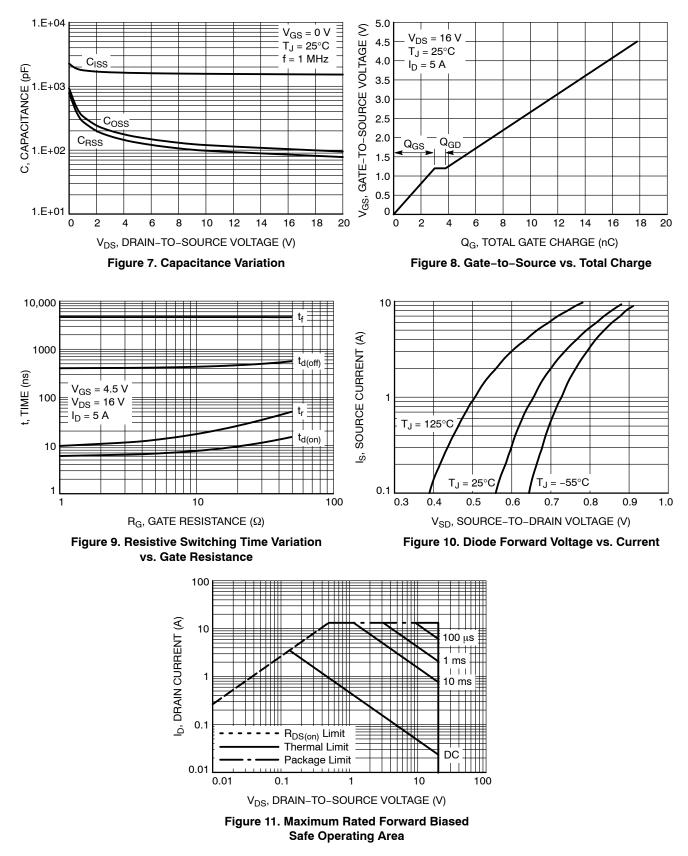
3. Pulse Test: pulse width \leq 300 ms, duty cycle \leq 2%.

4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

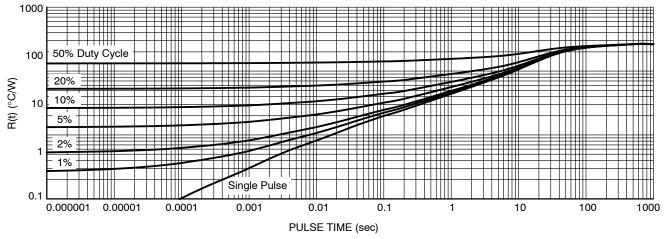
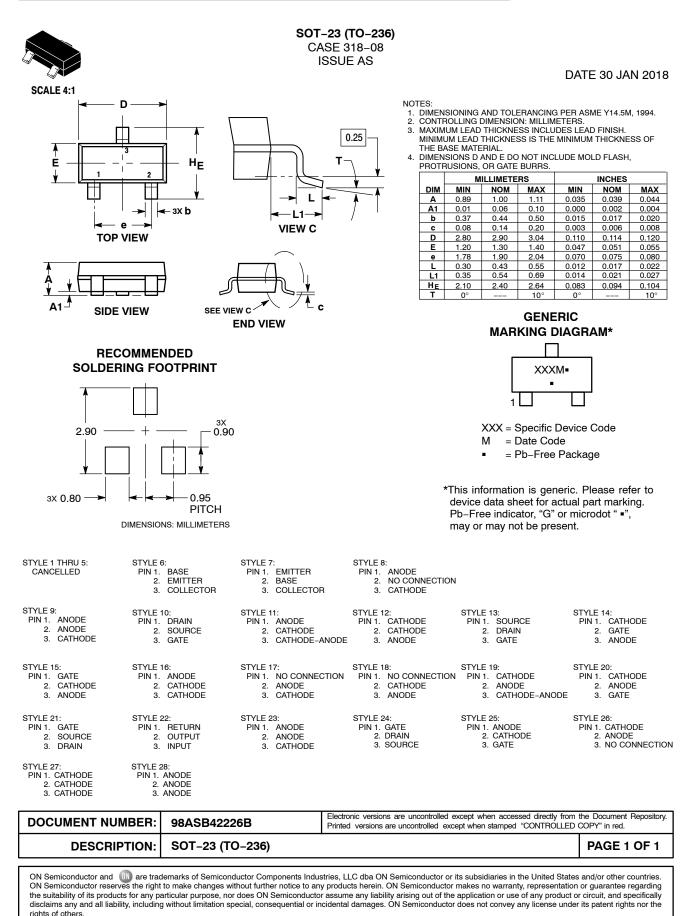


Figure 12. FET Thermal Response





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